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[SI5461EDC-T1-E3](#)

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**Si5461EDC**  
Vishay Siliconix

## P-Channel 20-V (D-S) MOSFET

### PRODUCT SUMMARY

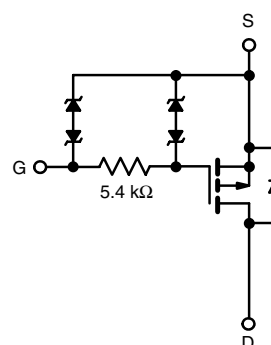
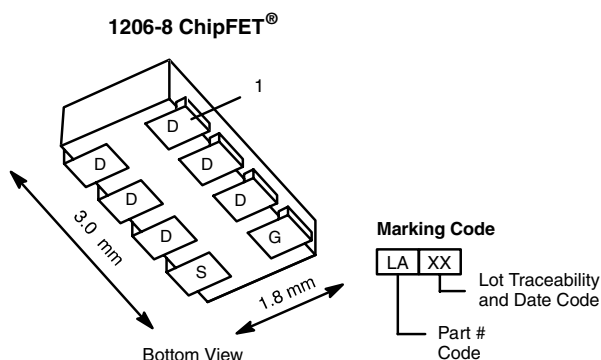
$V_{DS}$ (V)	$R_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)
- 20	0.045 at $V_{GS} = - 4.5$ V	- 6.2
	0.060 at $V_{GS} = - 2.5$ V	- 5.4
	0.082 at $V_{GS} = - 1.8$ V	- 4.6

### FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- ESD Protected<sup>b</sup> 5000 V



**RoHS**  
COMPLIANT  
**HALOGEN**  
**FREE**  
Available



**Ordering Information:** Si5461EDC-T1-E3 (Lead (Pb)-free)  
Si5461EDC-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ\text{C}$ , unless otherwise noted

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted					
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	- 20		V
Gate-Source Voltage		V <sub>GS</sub>	± 12		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 6.2	- 4.5	A
	T <sub>A</sub> = 85 °C		- 4.5	- 3.2	
Pulsed Drain Current		I <sub>DM</sub>	- 20		
Continuous Source Current <sup>a</sup>		I <sub>S</sub>	- 2.1	- 1.1	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5	1.3	W
	T <sub>A</sub> = 85 °C		1.3	0.7	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) <sup>c, d</sup>			260		

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	$R_{thJA}$	40	50	$^\circ\text{C/W}$
		80	95	
Maximum Junction-to-Foot (Drain)	$R_{thJF}$	15	20	

Notes:

- Surface Mounted on 1" x 1" FR4 board.
- When using HBM. The MM rating is 300 V.
- See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

# Si5461EDC

Vishay Siliconix



<b>SPECIFICATIONS</b> $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = -250\text{ }\mu\text{A}$	-0.45			V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 4.5\text{ V}$			$\pm 1.5$	$\mu\text{A}$
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -16\text{ V}$ , $V_{GS} = 0\text{ V}$			-1	
		$V_{DS} = -16\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 85\text{ }^{\circ}\text{C}$			-5	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \leq -5\text{ V}$ , $V_{GS} = -4.5\text{ V}$	-20			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}$ , $I_D = -5.0\text{ A}$		0.037	0.045	$\Omega$
		$V_{GS} = -2.5\text{ V}$ , $I_D = -4.0\text{ A}$		0.050	0.060	
		$V_{GS} = -1.8\text{ V}$ , $I_D = -2\text{ A}$		0.066	0.082	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -5\text{ V}$ , $I_D = -5.0\text{ A}$		12		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = -1.1\text{ A}$ , $V_{GS} = 0\text{ V}$		-0.7	-1.2	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{DS} = -10\text{ V}$ , $V_{GS} = -4.5\text{ V}$ , $I_D = -5.0\text{ A}$		12.5	20	nC
Gate-Source Charge	$Q_{gs}$			2.0		
Gate-Drain Charge	$Q_{gd}$			4.0		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -10\text{ V}$ , $R_L = 10\text{ }\Omega$ $I_D \cong -1\text{ A}$ , $V_{GEN} = -4.5\text{ V}$ , $R_G = 6\text{ }\Omega$		2.5	3.5	ns
Rise Time	$t_r$			4.5	8.0	
Turn-Off Delay Time	$t_{d(off)}$			27	40	
Fall Time	$t_f$			15	25	

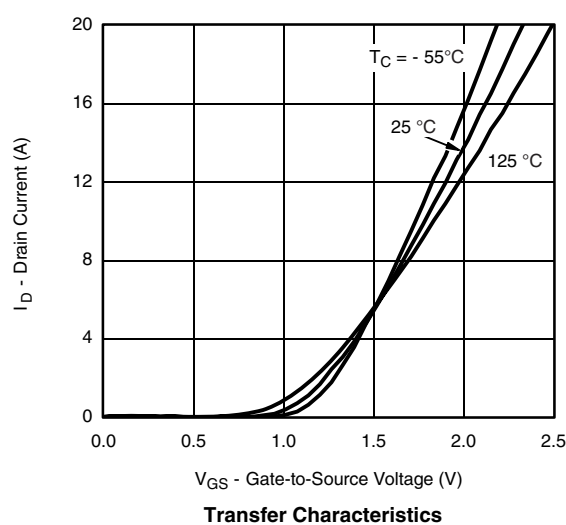
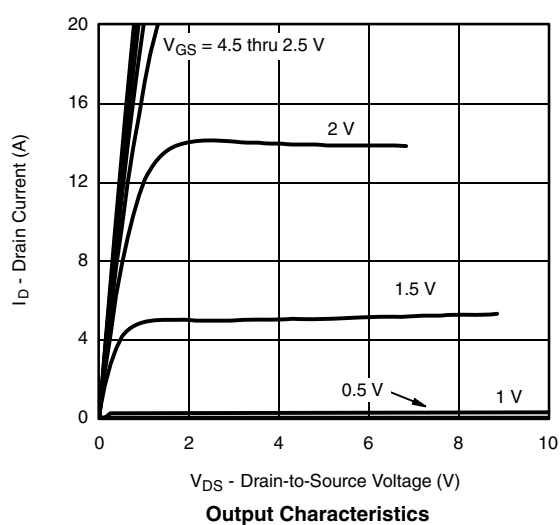
Notes:

a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## TYPICAL CHARACTERISTICS $25\text{ }^{\circ}\text{C}$ , unless otherwise noted

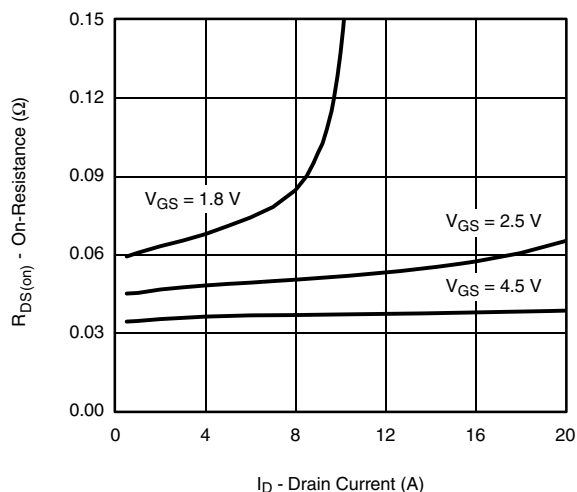




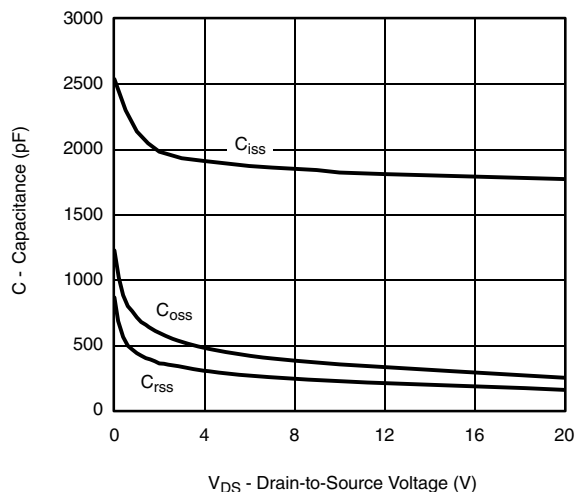
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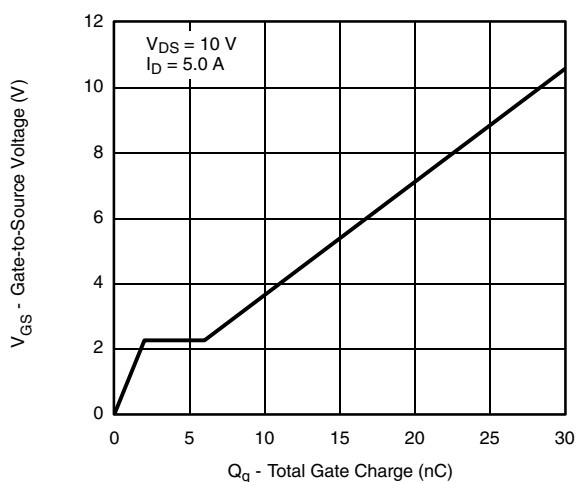
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



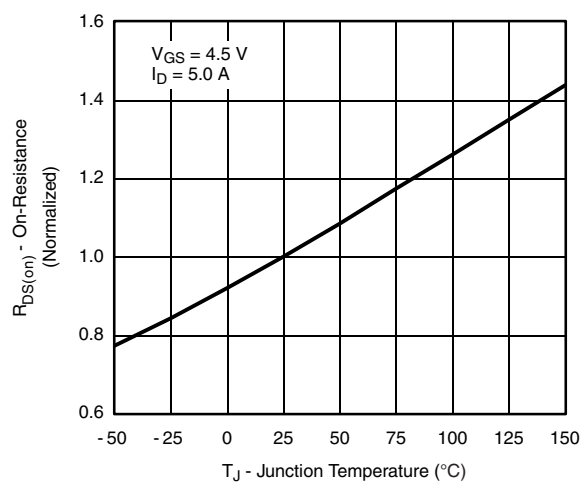
**On-Resistance vs. Drain Current**



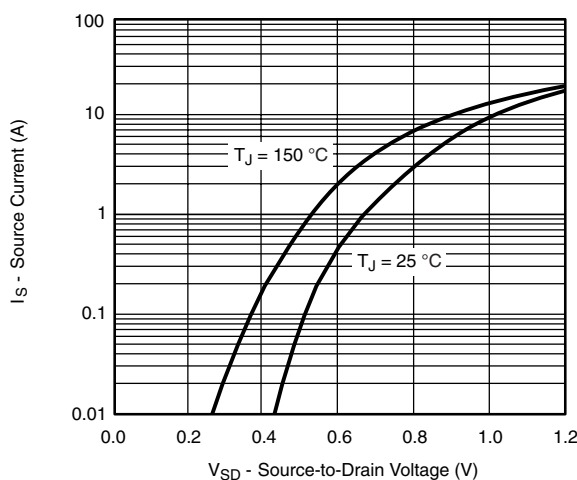
**Capacitance**



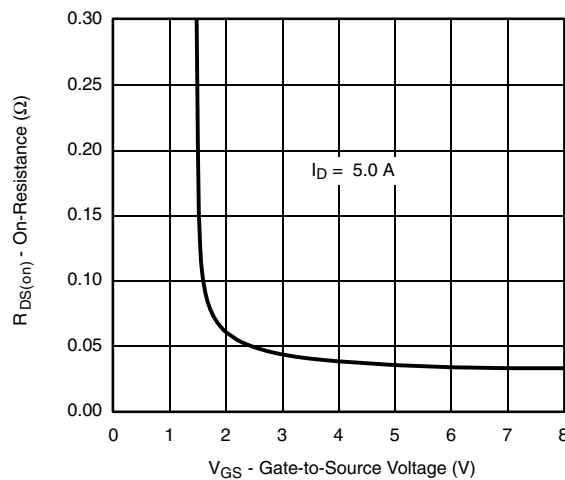
**Gate Charge**



**On-Resistance vs. Junction Temperature**



**Source-Drain Diode Forward Voltage**



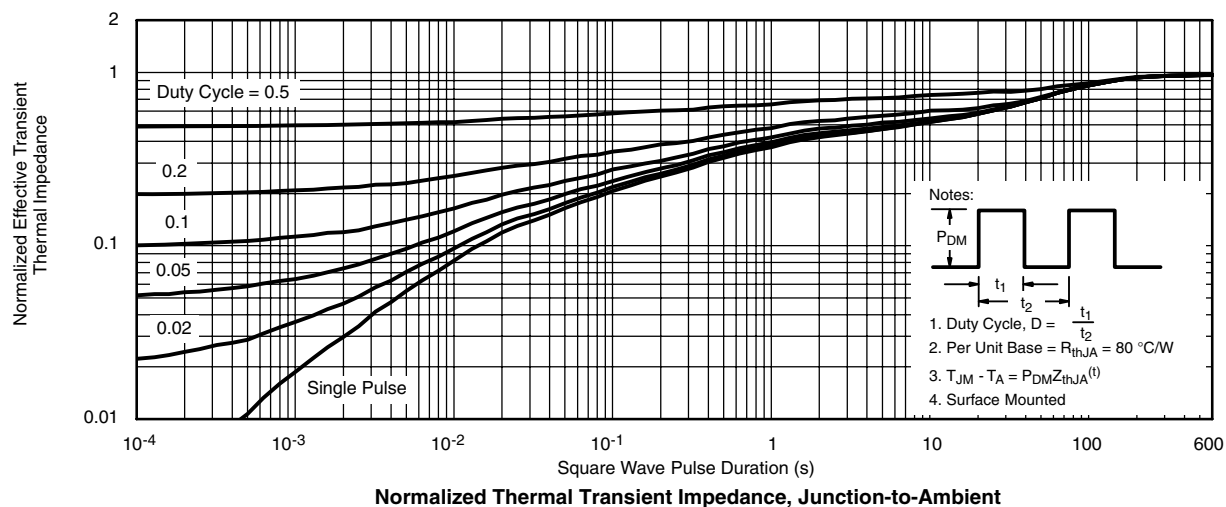
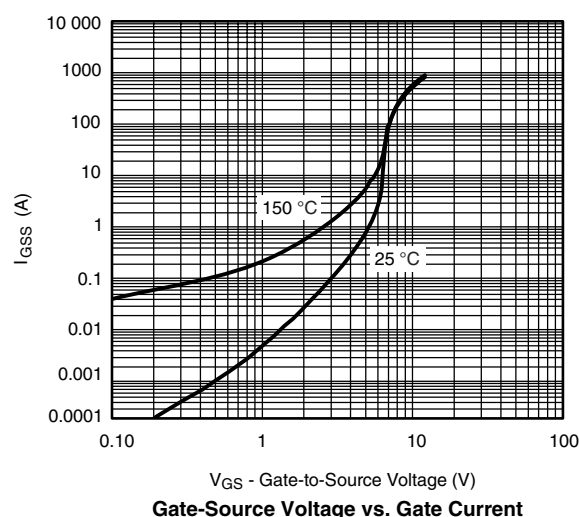
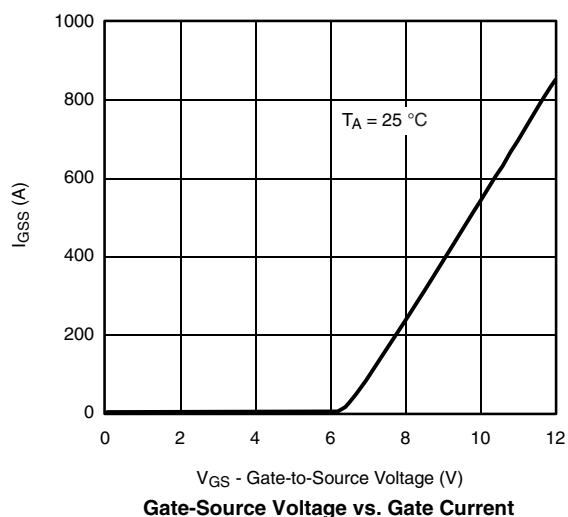
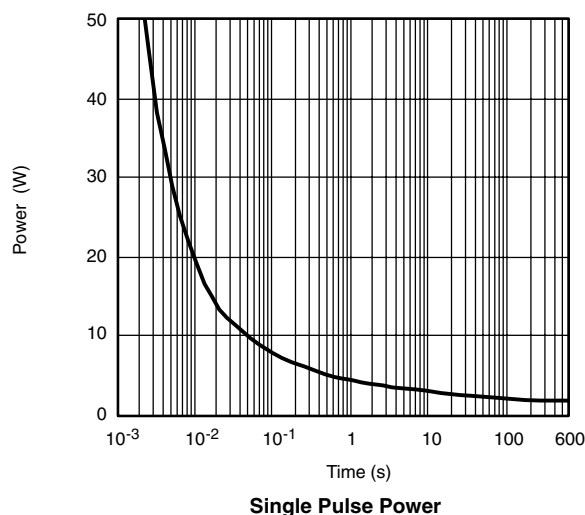
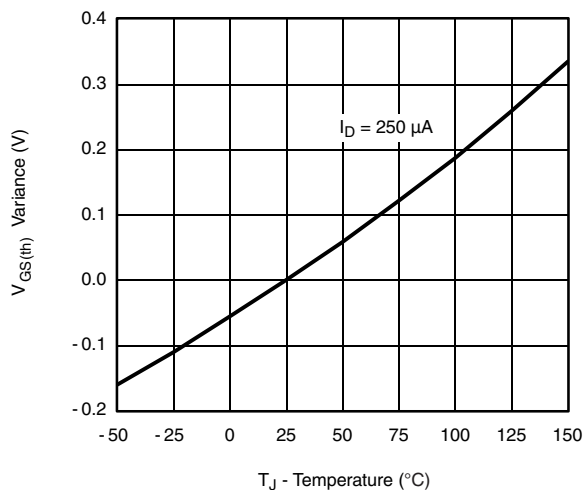
**On-Resistance vs. Gate-to-Source Voltage**

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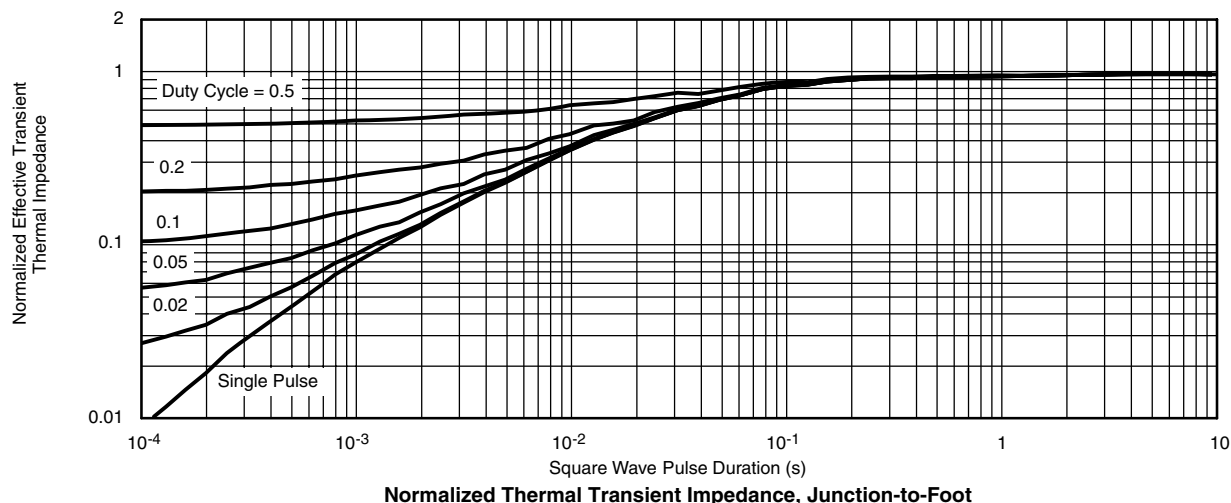




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